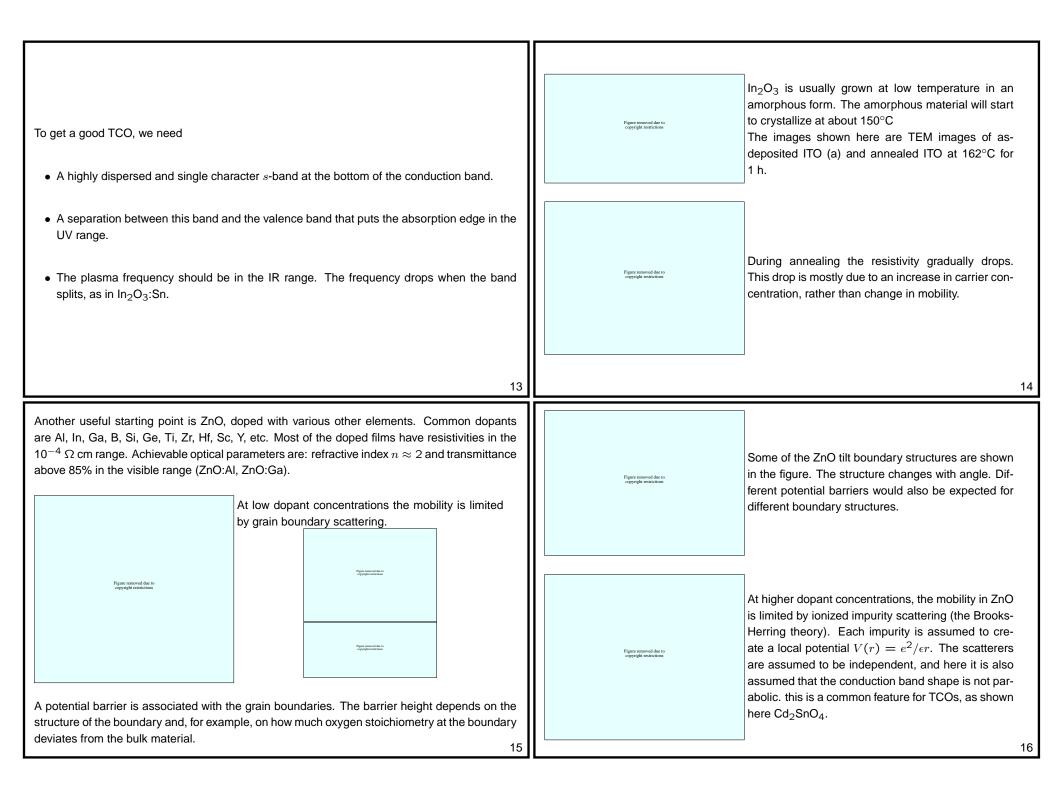


Ternary TCOs		'	The UV side		
Figure removed due to copyright restrictions	Another Sn-based TCO material is Cd_2SnO_4 . Absorption in the visible range is lower than SnO_2 due to a lower carrier concentration. Despite the lower carrier concentration, resistivity is actually lower due to a much higher mobility of carriers.		Figure ymowed dae to copyright restrictions	The carrier densities are A $0.4 \times 10^{20} \text{ cm}^{-3}$ B $1.7 \times 10^{20} \text{ cm}^{-3}$ C $6.2 \times 10^{20} \text{ cm}^{-3}$ D $8.0 \times 10^{20} \text{ cm}^{-3}$ The band gap shifts to higher energy with increasing carrier concentration. This is a common feature for heavily doped $\ln_2 O_3$. Normally for moderately doped semiconductors we might approximate the absorption edge with $\alpha = \sqrt{\hbar \omega - E_g}$	
Typical transport numbers are:					
$\label{eq:spectrum} \begin{array}{ c c c c } \hline \hline Property & SnO_2 & Cd_2SnO_4 \\ \hline Carrier density n & 5 \times 10^{20} \ cm^{-3} & 3.2 \times 10^{20} \ cm^{-3} \\ \hline mobility \mu & 15 \ cm^2 V^{-1} s^{-1} & 54 \ cm^2 V^{-1} s^{-1} \\ \hline resistance R & 16.7 \ \Omega/\Box & 7.2 \ \Omega/\Box \\ \hline \end{array}$			Figure reserved due to copyruph restrictions	Quite clearly, this is not a valid approximation here. The lowest levels of the conduction band are already full in a heavily-doped material and the Fermi level shifts into the conduction band. The absorption edge therefore shifts to higher energies as the carrier concentration in- creases (and the conduction band fills more).	
	9			10	
Several processes compete here: • The lowest levels in the conduction band are blocked, causing a widening of E_g .			Figure removed due to copyright restrictions	In_2O_3 has the bixbyite structure. Essentially cubic, but with oxygen vacancy ordering either along a face diagonal (In_2) or along a cube diagonal (In_1).	
 Electron-electron and electron-impurity scattering decrease the gap. That is why W < E_{g0}. The effective masses are not constant. There is a linear dependence between carrier concentration and effective mass. 			Figure removed due to copyright restrictions	Calculated band structure of undoped In_2O_3 . Gap is around 1 to 1.5 eV (depends on lat- tice constant), smaller than the experimental value of about 3.6 eV. Top of the valence band is made up of hy- bridized O $2p$ and In_2 5d states, bottom of	
Figure removed due to copyright restrictions	Considering only the first mechanism, the gap energy is given by $E_g = E_{g0} + \Delta E_g^{BM}$, where ΔE_g^{BM} is the Burstein-Moss energy shift,		Figure removed due to copyright restrictions	conduction band is hybridized O $2s$ and $\ln_{1,2}$ 5s. In ₂ O ₃ :Sn A second gap opens due to strong hybridiza- tion between O and In. Dispersion in the s	
				band is slightly reduced, corresponding to a	
	given by $\Delta E_g^{\rm BM}=\frac{\hbar^2}{2m_{vc}^*}(3\pi^2n_e)^{3/2}$ The plot shows data for a CdO thin film sample. 11	M	MRS Bull. Aug 2000 p.47	drop in mobility (as is observed experimen- tally).	



<i>p</i> -type TCOs		The energy levels:	
<i>p</i> -type TCOs Wide-gap materials like TCOs ure usually thought of as insulators. This is common for an ionic crystal. Donors also tend to be quite deep and charges localize easily. It is, however, interesting to look for conducting wide-gap oxides, especially <i>p</i> -type oxides. These could be combined with the better-known TCOs (all are <i>n</i> -type) in <i>pn</i> junctions (transparent electronics!). The TCOs that we have looked at so far, have a ns^0 electronic configuration. We now look how		Prevenue data de la catolit with a closed d'astiell. This prevents $d - d$ transitions, which would create absorption bands in the visible range. Refer to lecture 8: $\frac{Compound}{Cr_2O_3} = 3.3 \qquad 2.1,2.6$ MnO $3.6 \qquad 2.2,2.9,3.5$ FeO $2.4 \qquad 1.2$ α Fe ₂ O ₃ $1.9 \qquad 1.4,2.1,2.6,2.9$ CoO $2.6 \qquad 1.1,2.0,2.3$	
to design a <i>p</i> -type TCO.		NiO 3.8 1.1,1.8,3.2 MRS Bull. Aug 2000 p.28 Y ₃ Fe ₅ O ₁₂ 3 Many	
The first problem is the localization of introduced holes (on oxygen sites) in a strongly ionic compound. Localization effects can be reduced if we can choose a material with a more covalent bonding of oxygens.		To get a covalent bond, we need to have the cation d levels at about the same energy as the O $2p$ levels. The antibonding orbital between the metal and the oxygen will be the highest occupied orbital.	
The second problem is to select the most suitable cations and a suitable crystal structure.		We can consider two closed-shell configurations: $d^{10}s^0$ (Ag ⁺ , Cd ²⁺ , In ³⁺ , Sn ⁴⁺ , Sb ⁵⁺) and $d^{10}s^2$ (In ⁺ , Sn ²⁺ , Sb ³⁺). No <i>p</i> -type TCOs have been found in the $d^{10}s^2$ group so far. 18	
Figure researed due to suppregrammentations	A photoemission spectrum of $Cdln_2O_4$ spinel shows that it is indeed an <i>n</i> -type semiconductor with the Fermi edge close to the conduction band bottom. The gap width is about 3 eV. The conduction band top consists of O $2p$ lev- els. About 7 eV below oxygen is the Cd 4 <i>d</i> peak and 6 eV below that comes the ln 4 <i>d</i> peak.	Figure removed due to copyright restrictions We also need a suitable crystal structure to get the desired metal-oxygen bonding. One possible candidate is the delafossite structure. The general formula is AMO ₂ , where A is a monovalent cation and M is a trivalent metal ion. The structure is layered and hexagonal. The A-O distance is relatively large and there is no oxygen in the A layer. This abautid and there is no oxygen in the A layer. This	
	In general, atomic energy levels shift to lower energy with	should reduce repulsion problems between the closed shell of the A cation and oxygens, hopefully keeping the energy levels aligned.	
Figure reserved due to copyright restrictions	increasing atomic number, as shown here for $3d$ and $4d$ elements. This data applies to free ions, but the relative shifts should apply roughly to ions in a lattice as well. The Cd-In shift is about 6 eV, consistent with the UPS result. the plot shows that Ag ⁺ levels should almost overlap with O $2p$. Same arguments apply to Cu ⁺ .	Function $f_{\text{constraints}}$ Indeed, <i>p</i> -type conductivity has been found in this system. Examples are CuAlO ₂ and CuGaO ₂ . The band gap is around 3.5 eV for both materials.	
MRS Bull. Aug 2000 p.29			
	19	20	

	The resistivities of CuAlO ₂ (\bullet) and CuGaO ₂ (\bigcirc) are	Another <i>p</i> -type TCO candidate is SrCu ₂ O ₂		
Figure recoved due to copyright restrictions	similar; semiconducting at higher temperature and a hopping mechanism at lower temperatures. The activation energy is about 0.2 eV. Room-temperqature conductivity is not good, 9.5×10^{-1} S cm ⁻¹ in CuAlO ₂ and 6.3×10^{-2} S cm ⁻¹ in CuGaO ₂ , much worse than the 0.9×10^4 S cm -1 achieved by ITO. The Hall mobilities follow the resistivity data, giving 10.4 cm ² V -1 s ⁻¹ for CuAlO ₂ and only 0.23 cm ² V -1 s ⁻¹ for CuGaO ₂ .	Figure removed due to copyright restrictions	The Cu ⁺ ions are in zig-zag chains and only interact with oxygens within these chains. Conductivity can be modified by doping with potassium.	
		MRS Bull. Aug 2000 p.30		
Figure removed due to copyright restrictions	This plot shows that the Seebeck coefficient is also positive (CuAlO ₂), i.e. this is indeed a p -type material.	Figure sparsed due to copyright motivations	Room-temperature conductivity is still very low, only 4.8 \times 10 ⁻² S cm ⁻¹ . Band gap is 3.3 eV.	
	21	MRS Bull. Aug 2000 p.31	22	
Another strong candidate for use as a <i>p</i> -type TCO is doped ZnO. ZnO is intrinsically an <i>n</i> -type material due to oxygen vacancies and Zn interstistials in the lattice. Doping the lattice with N should give a <i>p</i> -type material. Unfortunately there is a strong repulsion between the N				
material due to oxygen vacancies	and Zn interstistials in the lattice. Doping the lattice with N should give a p -type material. Unfortunately there is a strong repulsion between the N	Figure removed due to copyright restrictions	<i>n</i> and <i>p</i> -type TCOs can be used to build transparent devices. This image shows the transmission spectrum of a pn junction and a photo of the device. The device consists of ZnO/ <i>n</i> -ZnO/ <i>p</i> -SCO/ITO layers. The junction is formed by the <i>n</i> -ZnO and <i>p</i> -SCO layers. ITO and ZnO are electrodes.	
material due to oxygen vacancies	and Zn interstistials in the lattice. Doping the lattice with N should give a <i>p</i> -type material. Unfortunately there is a strong repulsion between the N dopants, making this difficult. Also, the carriers introduced by the dopants, are localized.	Figure removed due to copyright restrictions	transparent devices. This image shows the transmission spectrum of a pn junction and a photo of the device. The device consists of ZnO/ n -ZnO/ p -SCO/ITO layers. The junction is formed by the n -ZnO and p -SCO layers.	
The second secon	and Zn interstistials in the lattice. Doping the lattice with N should give a p -type material. Unfortunately there is a strong repulsion between the N dopants, making this difficult. Also, the carriers introduced	copyright restrictions	transparent devices. This image shows the transmission spectrum of a pn junction and a photo of the device. The device consists of ZnO/ n -ZnO/ p -SCO/ITO layers. The junction is formed by the n -ZnO and p -SCO layers.	

 Low-emissivity windows: The plasma frequency is set at around 2 μm in cold climates to let the Sun's radiation in and also keep the long wavelength IR radiation inside. In hot climates the IR cut-off is set at ≈1 μm to keep the heat out. Windows use often metal layers (silver or TiN), enclosed between glass sheets to protect the metal layer. Solar cells: Usually based on SnO₂:F, which gives the best conductivity. On plastic substrates both ITO and ZnO can be used. Flat-panel displays: The layer needs to be patterned by etching. ITO is therefore used, although tin oxide would give better conductivity. ITO can also be grown at low temperatures to cover the organic color filters. ZnO will be used in the future. Electrochromic mirrors and windows: Based on two SnO₂:F layers with an organic electrochromic layer sandwitched between them. Used mostly in car rear-view mirrors. Defrosting windows: The first TCO application during in military airplanes to defrost the windows. Originally used SnO₂, now mostly ITO. Largest use in supermarket freezer windows. Car windows often use metal alloys sandwitched between glass layers. ITO cannot be used because the resistivity is too high for a 12V power supply. 	 Oven windows: New grills and ovens have a window for looking in. The glass surface should reflect IR to keep the oven hot and the window cool. Coatings must be thermally stable, mostly using SnO₂. Static dissipation: Used to cover copy machine glass plates and CRT tubes to remove static charge. Mostly SnO₂. Touch-panel controls: Coatings need to be very durable, resistivity is not critical. Common choice is SnO₂. Electromagnetic shielding: Coating of windows to prevent electromagnetic radiation from escaping (computer safety). Invisible circuits: Security circuits on windows and museum display cases.
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